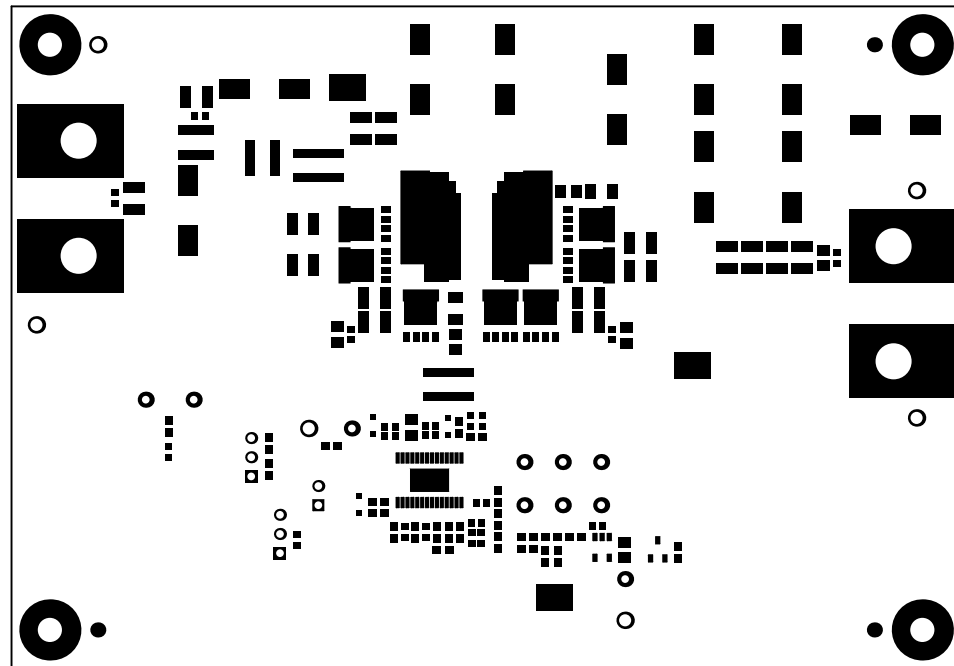
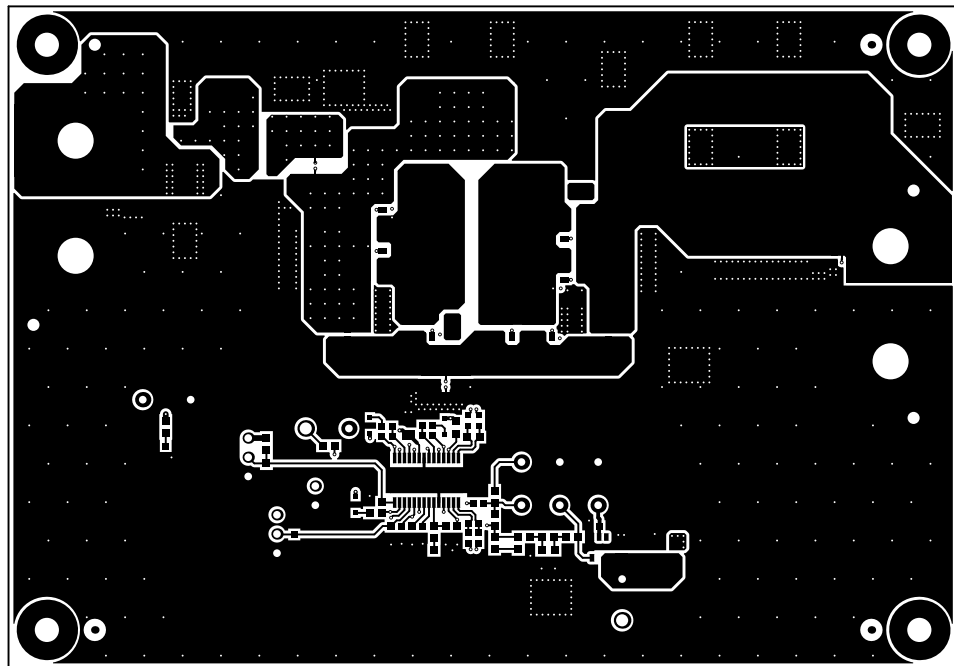


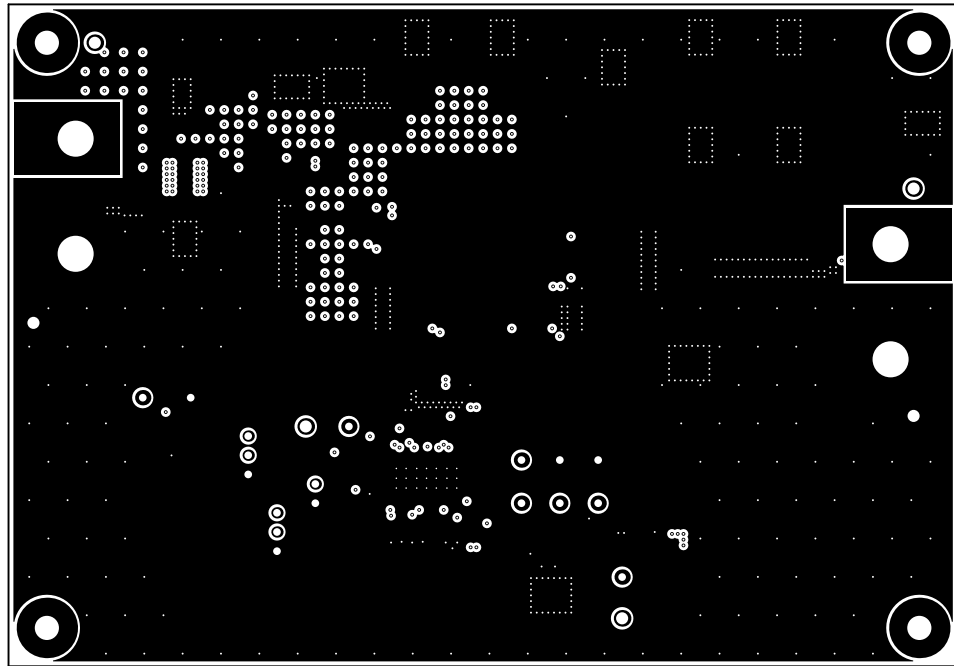
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 2/25/2019	6:52:37 PM	TEXAS INSTRUMENTS



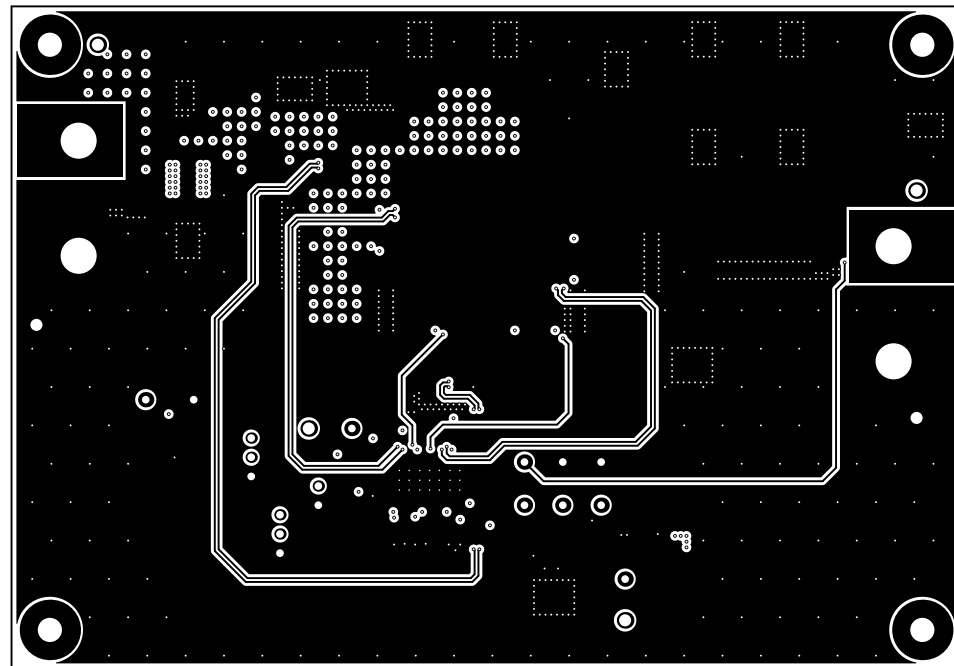
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 2/25/2019 6:52:38 PM	TEXAS INSTRUMENTS	



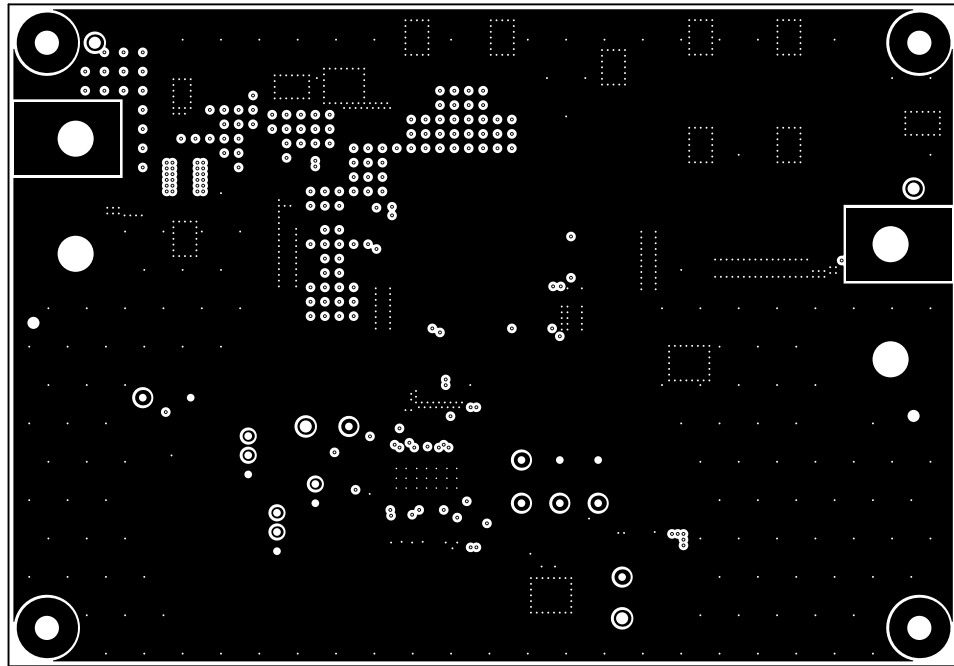
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 2/25/2019 6:52:40 PM	TEXAS INSTRUMENTS	



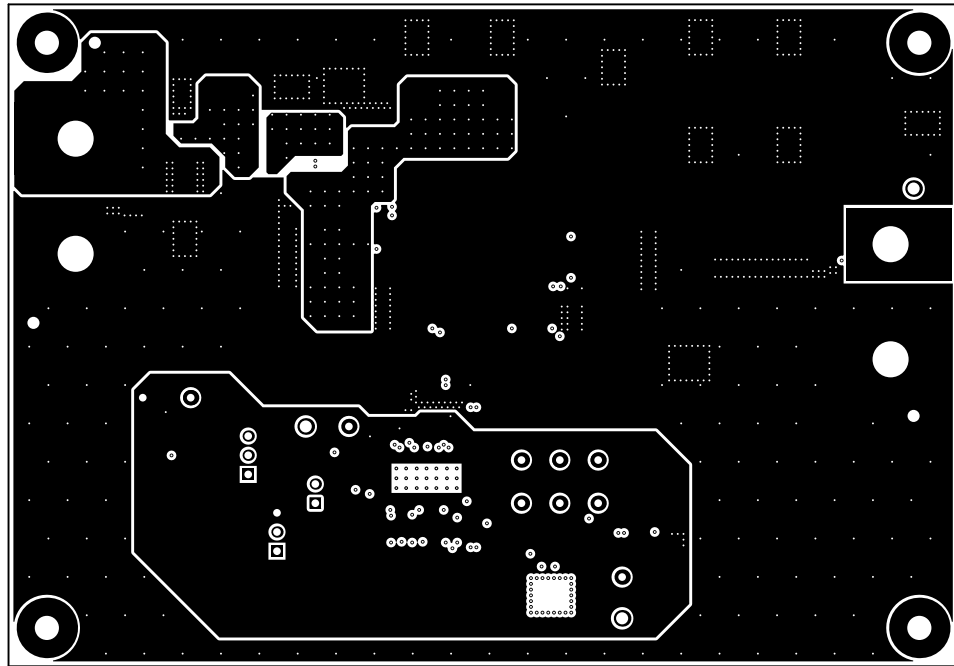
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 1	TID #: N/A		
PLOT NAME = Signal Layer 1	GENERATED : 2/25/2019 6:52:41 PM	TEXAS INSTRUMENTS	



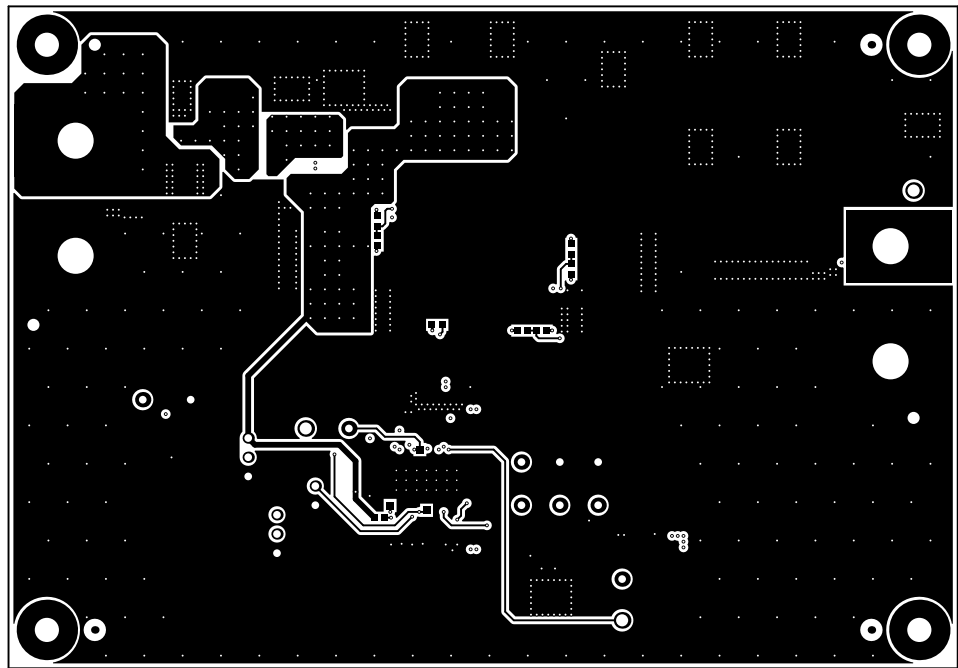
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 2	TID #: N/A		
PLOT NAME = Signal Layer 2	GENERATED : 2/25/2019 6:52:42 PM	TEXAS INSTRUMENTS	



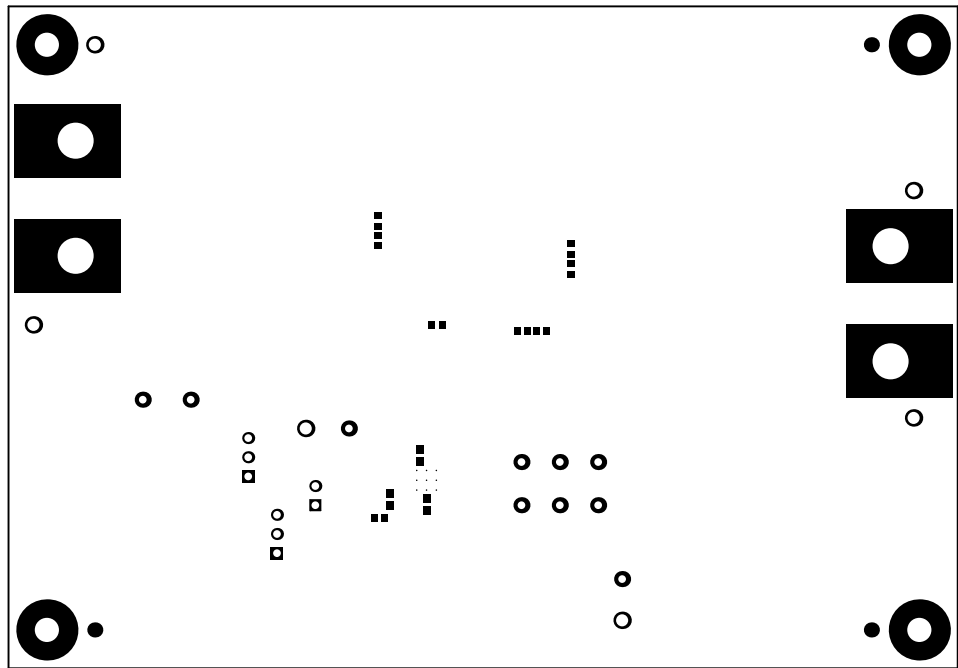
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 3	TID #: N/A		
PLOT NAME = Signal Layer 3	GENERATED : 2/25/2019 6:52:44 PM	TEXAS INSTRUMENTS	



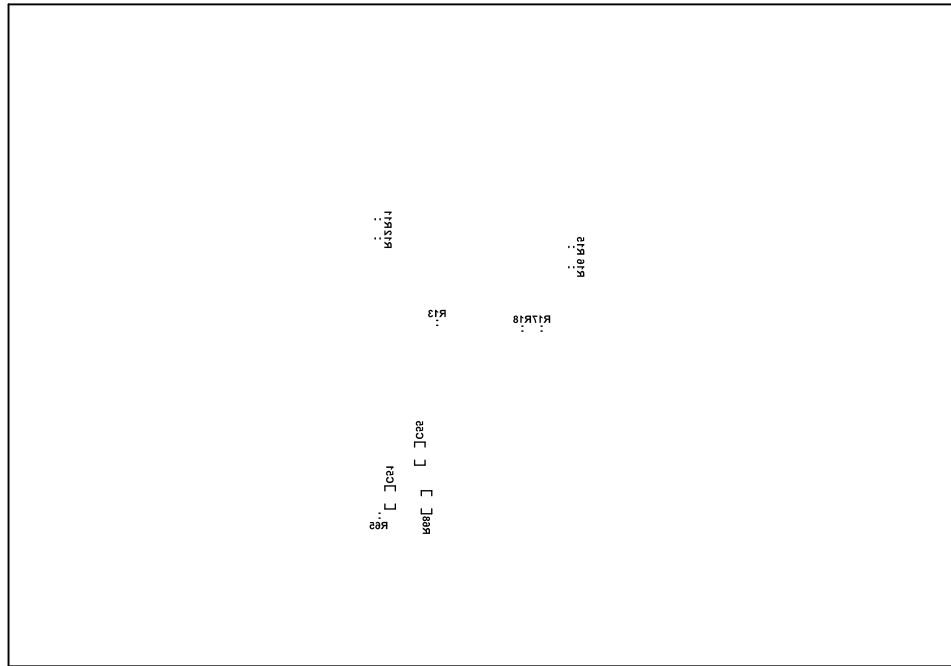
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 4	TID #: N/A		
PLOT NAME = Signal Layer 4	GENERATED : 2/25/2019 6:52:45 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 2/25/2019 6:52:46 PM	TEXAS INSTRUMENTS	

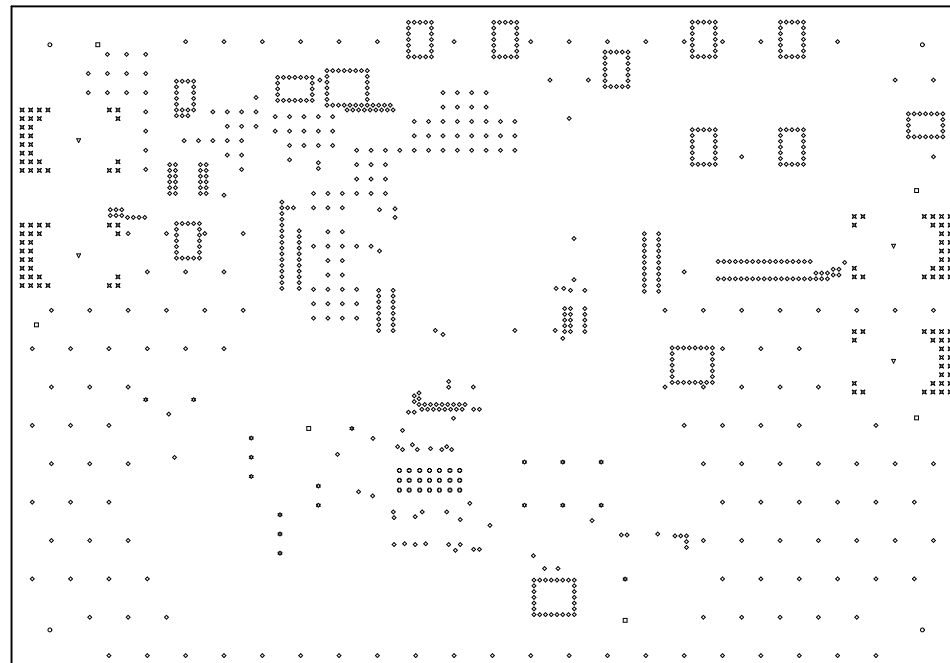


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/25/2019 6:52:48 PM	TEXAS INSTRUMENTS	

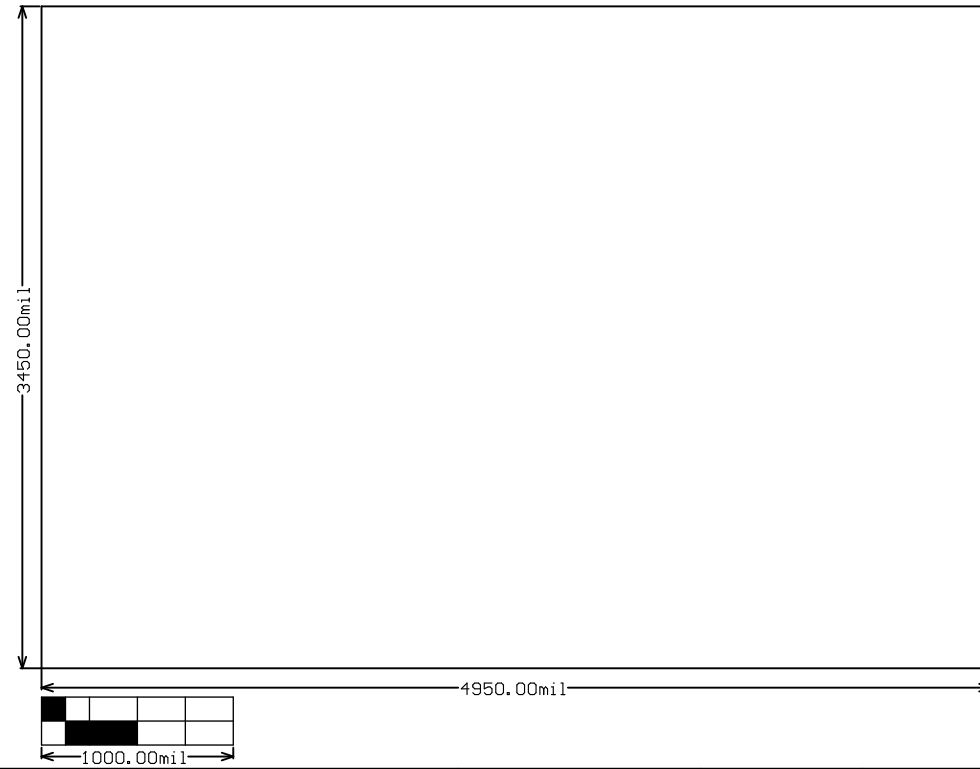


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 2/25/2019 6:52:49 PM	TEXAS INSTRUMENTS	

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded
▽	4	188.00mil (4.775mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rectangle
□	6	63.00mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded
⊗	18	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)
⊕	21	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
⊗	112	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
◇	820	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
	985 Total						



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 2/25/2019 6:52:51 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21697	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 2/25/2019 6:52:54 PM	TEXAS INSTRUMENTS	

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